# XP131A1715SR



ETR1106\_001a

#### Power MOSFET

#### ■GENERAL DESCRIPTION

The XP131A1715SR is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy

The small SOP-8 package makes high density mounting possible

#### ■APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

## **■**FEATURES

**Low On-State Resistance** : Rds(on)=  $0.012 \Omega$  (Vgs=4.5V)

: Rds(on)=  $0.015\Omega$  (Vgs=2.5V)

: Rds(on)=  $0.025 \Omega$  (Vgs=1.5V)

Ultra High-Speed Switching

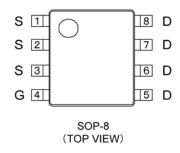
Driving Voltage : 1.5V

N-Channel Power MOSFET

**DMOS Structure** 

Package : SOP-8

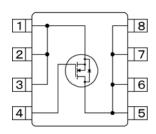
## **■PIN CONFIGURATION**



## ■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1~3	S	Source
4	G	Gate
5~8	D	Drain

## **■**EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

#### ■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	20	٧
Gate-Source Voltage	Vgss	±8	٧
Drain Current (DC)	ld	10	Α
Drain Current (Pulse)	ldp	40	Α
Reverse Drain Current	ldr	10	Α
Channel Power Dissipation *	Pd	2.5	W
Channel Temperature	Tch	150	°C
Storage Temperature Range	Tstg	-55~150	°C

<sup>\*</sup> When implemented on a glass epoxy PCB

## **■**ELECTRICAL CHARACTERISTICS

DC Characteristics Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=20V, Vgs=0V	-	-	10	μΑ
Gate-Source Leak Current	lgss	Vgs=±8V, Vds=0V	-	-	±1	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	Id=1mA, Vds=10V	0.5	-	1.2	V
	Rds(on)	Id=5A, Vgs=4.5V	-	0.009	0.012	Ω
Drain-Source On-State Resistance *		Id=5A, Vgs=2.5V	-	0.011	0.015	Ω
		Id=1.5A, Vgs=1.5V	-	0.017	0.025	Ω
Forward Transfer Admittance*	Yfs	ld=5A, Vds=10V	-	34	-	S
Body Drain Diode Forward Voltage	Vf	If=10A, Vgs=0V	-	0.8	1.1	٧

<sup>\*</sup> Effective during pulse test.

## **Dynamic Characteristics**

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds=10V, Vgs=0V f=1MHz	-	2000	-	pF
Output Capacitance	Coss		-	1000	-	pF
Feedback Capacitance	Crss		-	450	-	pF

## **Switching Characteristics**

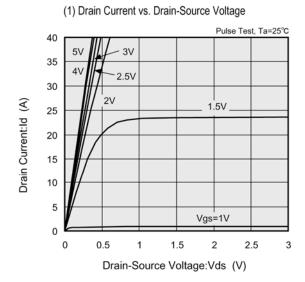
Ta = 25°C

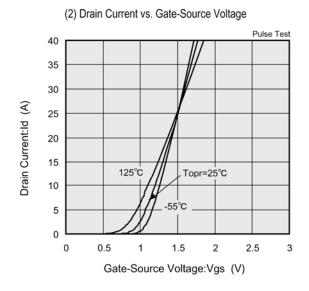
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=5V, Id=5A Vdd=10V	ı	15	1	ns
Rise Time	tr		ı	25	ı	ns
Turn-Off Delay Time	td (off)		-	95	-	ns
Fall Time	tf		-	15	-	ns

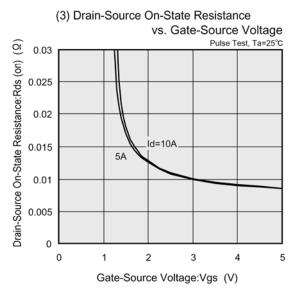
#### **Thermal Characteristics**

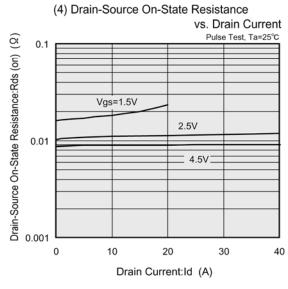
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	50	-	°C/W

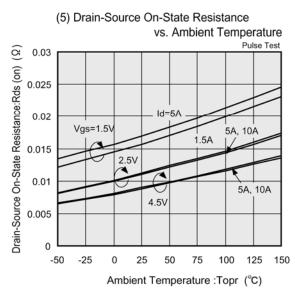
## ■TYPICAL PERFORMANCE CHARACTERISTICS

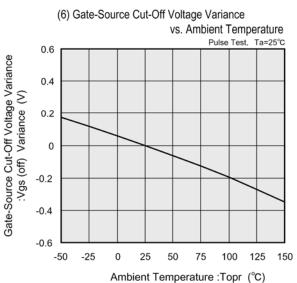




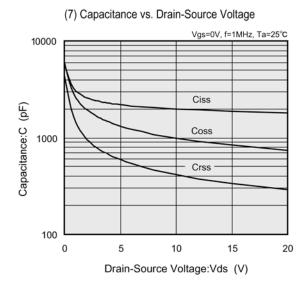


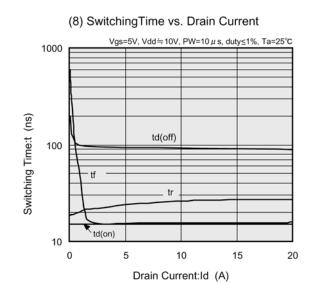




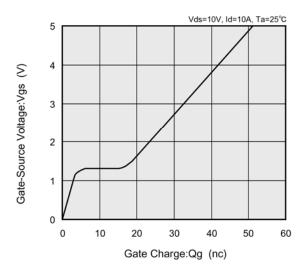


# ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

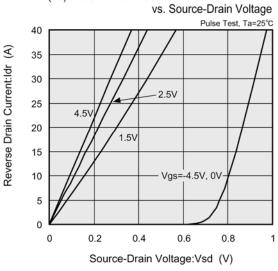




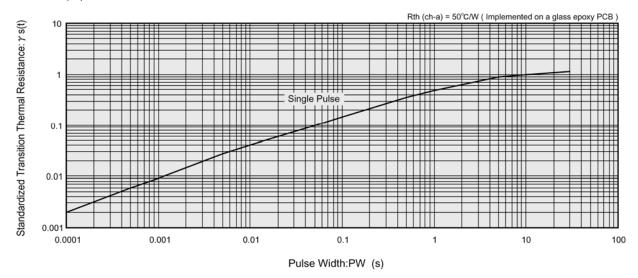








(11) Standardized transition Thermal Resistance vs. Pulse Width



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